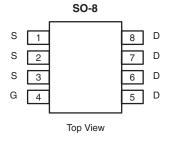


Vishay Siliconix

## N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
30	0.0115 at V <sub>GS</sub> = 10 V	12 <sup>e</sup>	13.7 nC			
30	0.0145 at V <sub>GS</sub> = 4.5 V	12 <sup>e</sup>	13.7 110			



Ordering Information: Si4646DY-T1-E3 (Lead (Pb)-free)

Si4646DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

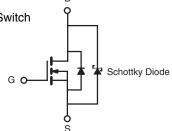
- Halogen-free According to IEC 61249-2-21 Definition
- SkyFET<sup>®</sup> Monolithic TrenchFET<sup>®</sup> Power MOSFET and Schottky Diode
- 100 % R<sub>q</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





#### **APPLICATIONS**

- Notebook PC
  - System Power
- Buck Converter
- Synchronous Rectifier Switch



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 2$	5 °C, unless other	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	30	V		
Gate-Source Voltage	$V_{GS}$	± 20	V		
	T <sub>C</sub> = 25 °C		12 <sup>e</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	12 <sup>e</sup>		
Commission Prairie Carrotte (1) = 100 °C)	T <sub>A</sub> = 25 °C	טי	12 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		9.5 <sup>b, c</sup>	Α	
Pulsed Drain Current	I <sub>DM</sub>	50	A		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	5.6		
Continuous Gource Brain Blode Guirent	T <sub>A</sub> = 25 °C	'5	2.7 <sup>b, c</sup>		
Single Pulse Avalanche Current Single Pulse Avalanche Energy  L = 0.1 mH		I <sub>AS</sub>	20	ı	
		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		6.25		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	4.0	W	
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C		3.0 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		1.9 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Тур.	Max.	Unit			
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	$R_{thJA}$	33	42	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	16	20	0, 11		

#### Notes

- a. Based on  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. Maximum under Steady State conditions is 90 °C/W.
- e. Package limited.

## **Si4646DY**

## Vishay Siliconix



<b>SPECIFICATIONS</b> $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	30			V		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 1 \text{ mA}$	1.2		2.5	-		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$		0.035	0.2	mA		
Zero date voltage Brain Guiterit	פפטי	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$		3.5	5 35			
On -State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α		
Durin Course On Olate Besidence	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		0.0092	0.0115			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0115	0.0145	Ω		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		38		S		
Dynamic <sup>b</sup>		<u>'</u>		•				
Input Capacitance	C <sub>iss</sub>			1790				
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		310		pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	1		130				
Total Cata Chargo	0	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		30	45	nC		
Total Gate Charge	$Q_g$			13.7	21			
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		5				
Gate-Drain Charge	$Q_{gd}$			4				
Gate Resistance	$R_{g}$	f = 1 MHz	0.3	1.2	2.4	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			23	45			
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_{L}$ = 1.5 $\Omega$		13	25			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		29	55			
Fall Time	t <sub>f</sub>	1		12	24			
Turn-On Delay Time	t <sub>d(on)</sub>			11	22	ns		
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		10	20			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		22	45			
Fall Time	t <sub>f</sub>	1		8	16			
Drain-Source Body Diode and Schottky Characteristics								
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			5.6			
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	Α		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2 A		0.53	0.7	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			17	30	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1 10 4 31/31 100 1/ 7 5-00		5.5	10	nC		
Reverse Recovery Fall Time		$I_F = 10 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 \text{ °C}$		8		ns		

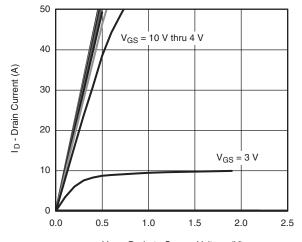
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



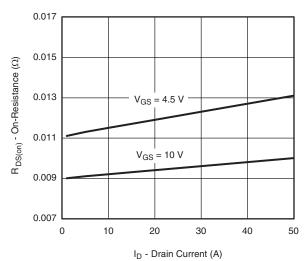
## Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

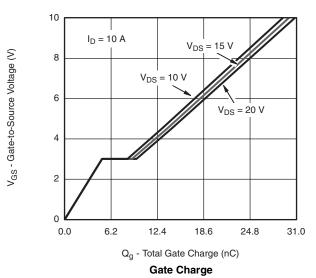


V<sub>DS</sub> - Drain-to-Source Voltage (V)



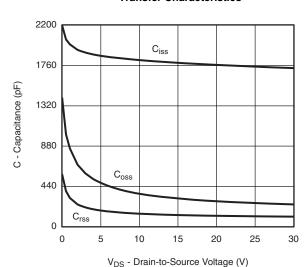


On-Resistance vs. Drain Current

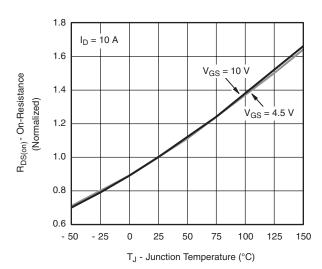


5 I<sub>D</sub> - Drain Current (A) 3 T<sub>C</sub> = 25 °C 2 T<sub>C</sub> = 125 °C 1 T<sub>C</sub> = - 55 °C 0 0 2 4 5

V<sub>GS</sub> - Gate-to-Source Voltage (V) **Transfer Characteristics** 



#### Capacitance



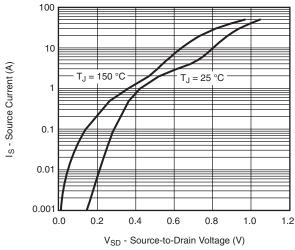
On-Resistance vs. Junction Temperature

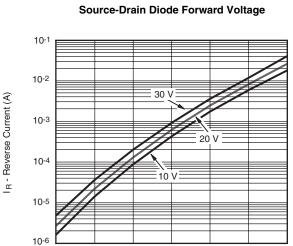
## **Si4646DY**

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





T<sub>J</sub> - Junction Temperature (°C)
Reverse Current (Schottky)

75

100

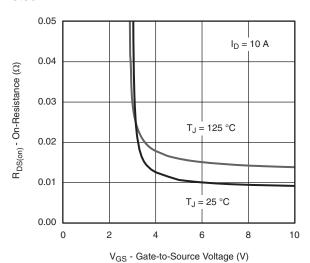
125

150

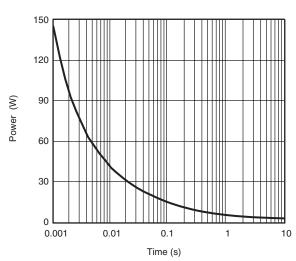
25

0

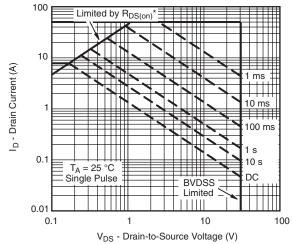
50



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



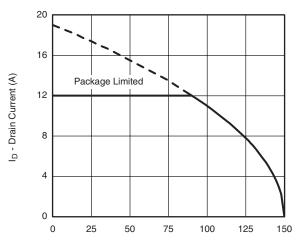
\*  $V_{GS} > \mbox{minimum } V_{GS}$  at which  $R_{DS(on)}$  is specified

**Safe Operating Area** 



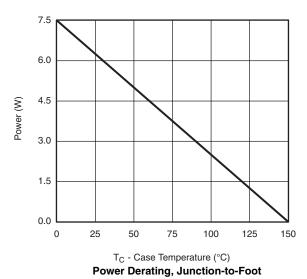
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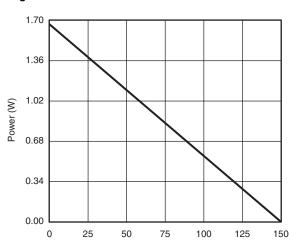
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T<sub>C</sub> - Case Temperature (°C)

#### **Current Derating\***





T<sub>A</sub> - Ambient Temperature (°C) **Power Derating, Junction-to-Ambient** 

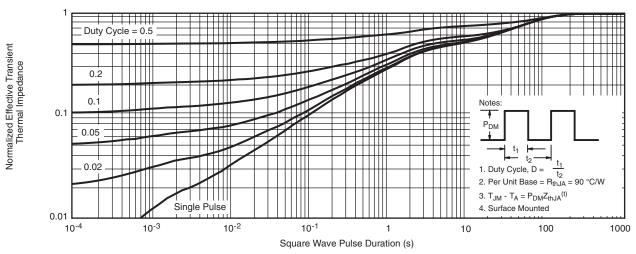
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

## **Si4646DY**

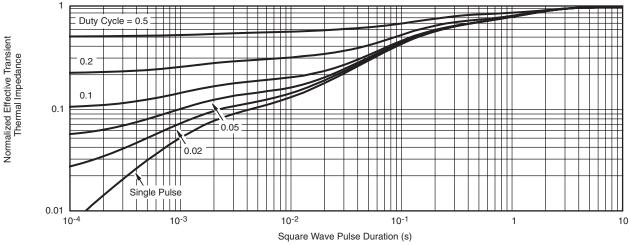
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	) BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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